



Samsung M471B5273DM0-CH9 memory module 4 GB 1 x 4 GB DDR3 1333 MHz

Brand : Samsung

Product code: M471B5273DM0-CH9

Product name : M471B5273DM0-CH9



4GB DDR3 SODIMM, 1333 MHz, CL9

Samsung M471B5273DM0-CH9. Component for: Laptop, Internal memory: 4 GB, Memory layout (modules x size): 1 x 4 GB, Internal memory type: DDR3, Memory clock speed: 1333 MHz, Memory form factor: 204-pin SO-DIMM, CAS latency: 9

Features		Features	
Buffered memory type	Unregistered (unbuffered)	Memory clock speed *	1333 MHz
CAS latency	9	Component for *	Laptop
Internal memory *	4 GB	Memory form factor *	204-pin SO-DIMM
Memory layout (modules x size) *	1 x 4 GB	ECC *	✗
Internal memory type *	DDR3	Memory voltage	1.5 V
		Operational conditions	
		Operating temperature (T-T)	0 - 85 °C

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